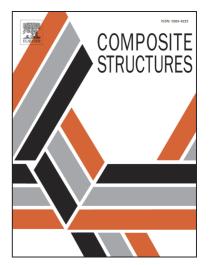
Accepted Manuscript

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PII:	S0263-8223(14)00681-3
DOI:	http://dx.doi.org/10.1016/j.compstruct.2014.12.025
Reference:	COST 6085

To appear in: *Composite Structures*



Please cite this article as: Jin, T., Ha, N.S., Le, V.T., Goo, N.S., Thermal buckling measurement of a laminated composite plate under a uniform temperature distribution using the digital image correlation method, *Composite Structures* (2014), doi: http://dx.doi.org/10.1016/j.compstruct.2014.12.025

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ACCEPTED MANUSCRIPT

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